

An ideal Si p-n junction diode with cross-sectional area  $A=0.001 \text{ cm}^2$  had been fabricated in your lab, and the voltage drop ( $V_{bi} = 0.6946\text{V}$ ) across the depletion region under equilibrium conditions (zero bias) was measured with the tools you developed. You also developed a system that visualizes the depletion width ( $W=9.6 \times 10^{-5}\text{cm}$ ) of the diode under the equilibrium conditions. In order to test the diode you applied a forward bias ( $V_A$ ) of  $0.65\text{V}$ .

**Find current (I) with a forward bias ( $V_A=0.65 \text{ V}$ ) at room temperature (300 K).**

Assume that the current is diffusion dominated, and total number of acceptor atoms ( $N_A$ ) is less than that of donor atoms ( $N_D$ ). The electron ( $\tau_n$ ) and hole ( $\tau_p$ ) minority-carrier lifetime is  $2.5\text{ms}$ , respectively.

Physical constants: Electronic charge  $q= 1.60 \times 10^{-19} \text{ C}$ ,

Intrinsic carrier concentration at 300 K  $n_i = 1.5 \times 10^{10} / \text{cm}^3$

Boltzmann's constant  $k=1.38 \times 10^{-23} \text{ J/K}$

Permittivity of free space  $\epsilon_0=8.85 \times 10^{-14} \text{ F/cm}$

Relative dielectric constant of Si  $K_s= 11.8$

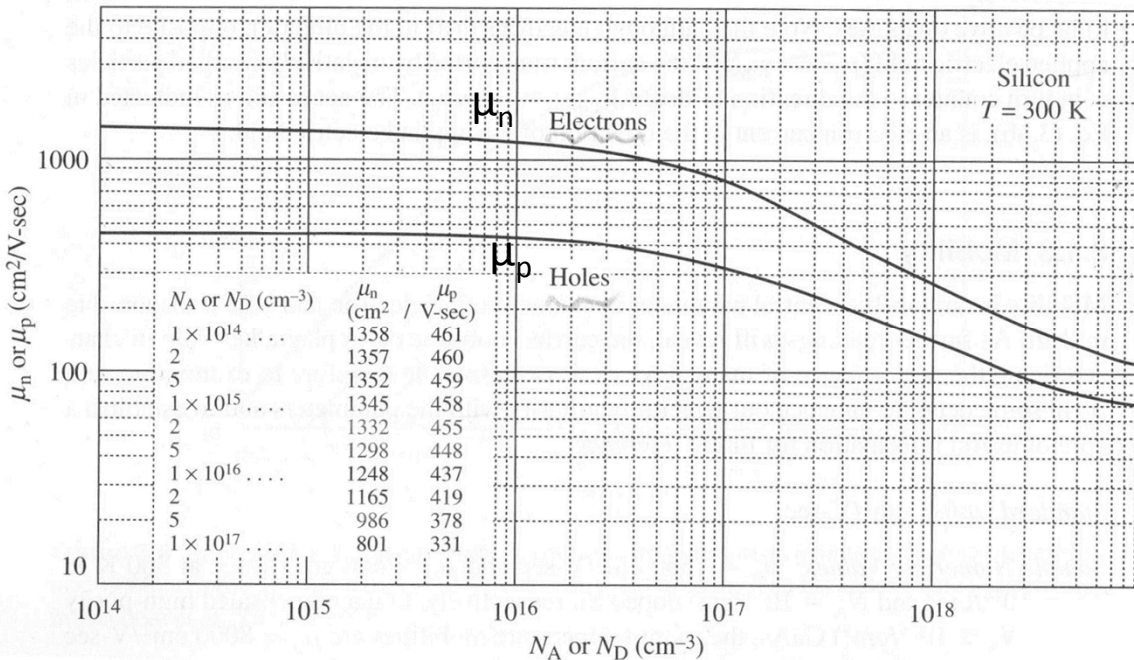
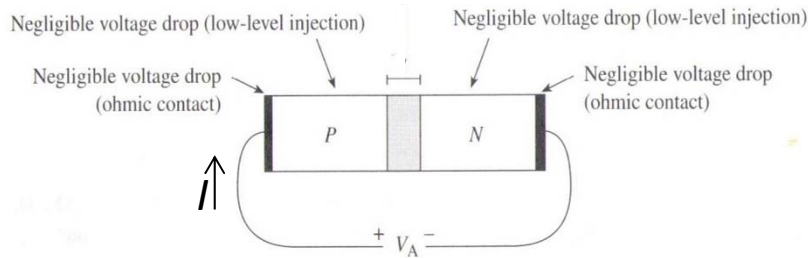


Figure 1. Room temperature carrier mobilities as a function of the dopant concentration in Si.  $\mu_n$  is the electron mobility;  $\mu_p$  is the hole mobility.